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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	33MHz
Connectivity	UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	33
Program Memory Size	8KB (4K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	454 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17c43-33-pt

5.2 Peripheral Interrupt Enable Register (PIE)

This register contains the individual flag bits for the Peripheral interrupts.

FIGURE 5-3: PIE REGISTER (ADDRESS: 17h, BANK 1)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0	R/W - 0
RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE
bit7							bit0
<p>bit 7: RBIE: PORTB Interrupt on Change Enable bit 1 = Enable PORTB interrupt on change 0 = Disable PORTB interrupt on change</p> <p>bit 6: TMR3IE: Timer3 Interrupt Enable bit 1 = Enable Timer3 interrupt 0 = Disable Timer3 interrupt</p> <p>bit 5: TMR2IE: Timer2 Interrupt Enable bit 1 = Enable Timer2 interrupt 0 = Disable Timer2 interrupt</p> <p>bit 4: TMR1IE: Timer1 Interrupt Enable bit 1 = Enable Timer1 interrupt 0 = Disable Timer1 interrupt</p> <p>bit 3: CA2IE: Capture2 Interrupt Enable bit 1 = Enable Capture interrupt on RB1/CAP2 pin 0 = Disable Capture interrupt on RB1/CAP2 pin</p> <p>bit 2: CA1IE: Capture1 Interrupt Enable bit 1 = Enable Capture interrupt on RB2/CAP1 pin 0 = Disable Capture interrupt on RB2/CAP1 pin</p> <p>bit 1: TXIE: USART Transmit Interrupt Enable bit 1 = Enable Transmit buffer empty interrupt 0 = Disable Transmit buffer empty interrupt</p> <p>bit 0: RCIE: USART Receive Interrupt Enable bit 1 = Enable Receive buffer full interrupt 0 = Disable Receive buffer full interrupt</p>							

R = Readable bit
W = Writable bit
-n = Value at POR reset

FIGURE 9-5: BLOCK DIAGRAM OF RB3 AND RB2 PORT PINS

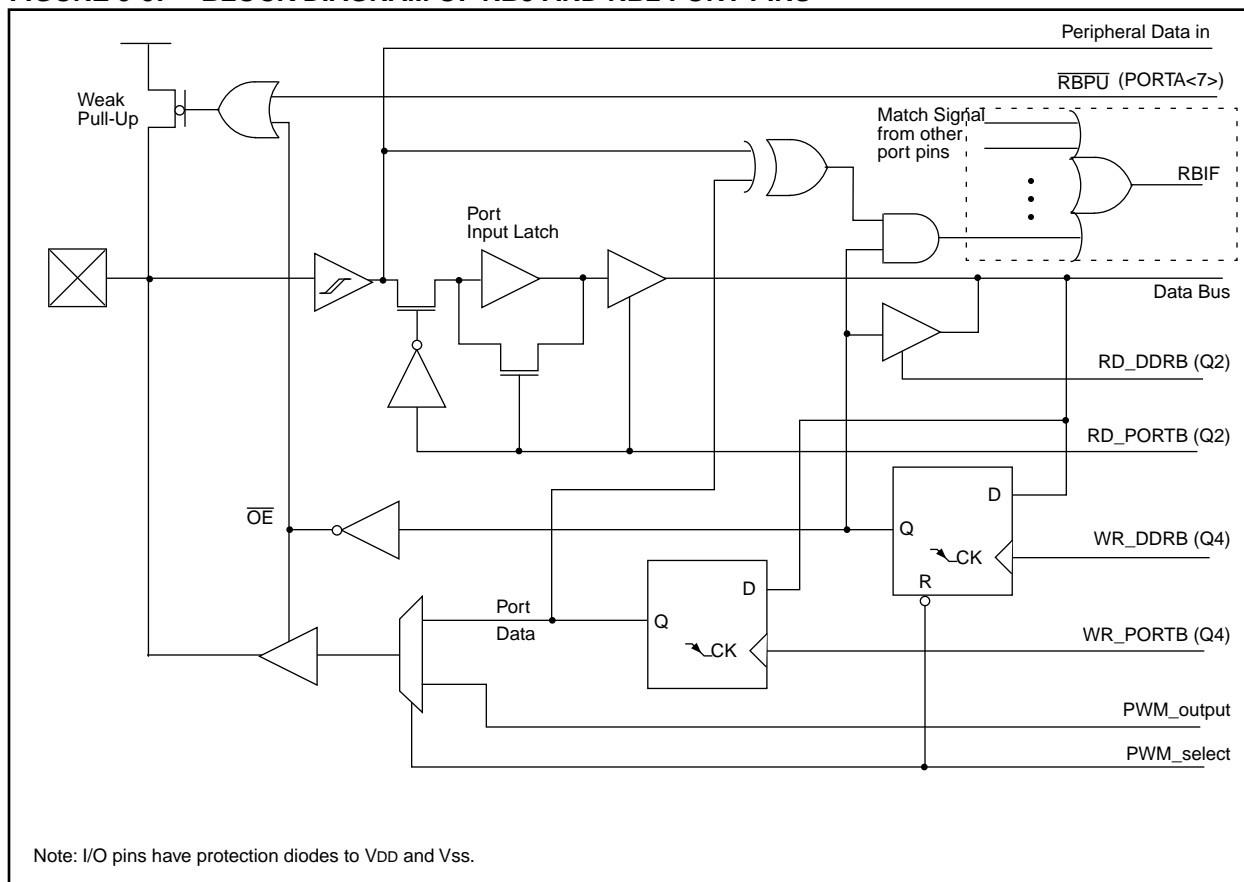


TABLE 9-5: PORTC FUNCTIONS

Name	Bit	Buffer Type	Function
RC0/AD0	bit0	TTL	Input/Output or system bus address/data pin.
RC1/AD1	bit1	TTL	Input/Output or system bus address/data pin.
RC2/AD2	bit2	TTL	Input/Output or system bus address/data pin.
RC3/AD3	bit3	TTL	Input/Output or system bus address/data pin.
RC4/AD4	bit4	TTL	Input/Output or system bus address/data pin.
RC5/AD5	bit5	TTL	Input/Output or system bus address/data pin.
RC6/AD6	bit6	TTL	Input/Output or system bus address/data pin.
RC7/AD7	bit7	TTL	Input/Output or system bus address/data pin.

Legend: TTL = TTL input.

TABLE 9-6: REGISTERS/BITS ASSOCIATED WITH PORTC

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
11h, Bank 1	PORTC	RC7/ AD7	RC6/ AD6	RC5/ AD5	RC4/ AD4	RC3/ AD3	RC2/ AD2	RC1/ AD1	RC0/ AD0	xxxx xxxx	uuuu uuuu
10h, Bank 1	DDRC	Data direction register for PORTC								1111 1111	1111 1111

Legend: x = unknown, u = unchanged.

Note 1: Other (non power-up) resets include: external reset through $\overline{\text{MCLR}}$ and the Watchdog Timer Reset.

11.3 Read/Write Consideration for TMR0

Although TMR0 is a 16-bit timer/counter, only 8-bits at a time can be read or written during a single instruction cycle. Care must be taken during any read or write.

11.3.1 READING 16-BIT VALUE

The problem in reading the entire 16-bit value is that after reading the low (or high) byte, its value may change from FFh to 00h.

Example 11-1 shows a 16-bit read. To ensure a proper read, interrupts must be disabled during this routine.

EXAMPLE 11-1: 16-BIT READ

```

MOVFP  TMR0L, TMPLO    ;read low tmr0
MOVFP  TMR0H, TMPHI    ;read high tmr0
MOVFP  TMPLO, WREG      ;tmplo -> wreg
CPFSLT TMR0L           ;tmr0l < wreg?
RETURN                ;no then return
MOVFP  TMR0L, TMPLO    ;read low tmr0
MOVFP  TMR0H, TMPHI    ;read high tmr0
RETURN                ;return
    
```

11.3.2 WRITING A 16-BIT VALUE TO TMR0

Since writing to either TMR0L or TMR0H will effectively inhibit increment of that half of the TMR0 in the next cycle (following write), but not inhibit increment of the other half, the user must write to TMR0L first and TMR0H next in two consecutive instructions, as shown in Example 11-2. The interrupt must be disabled. Any write to either TMR0L or TMR0H clears the prescaler.

EXAMPLE 11-2: 16-BIT WRITE

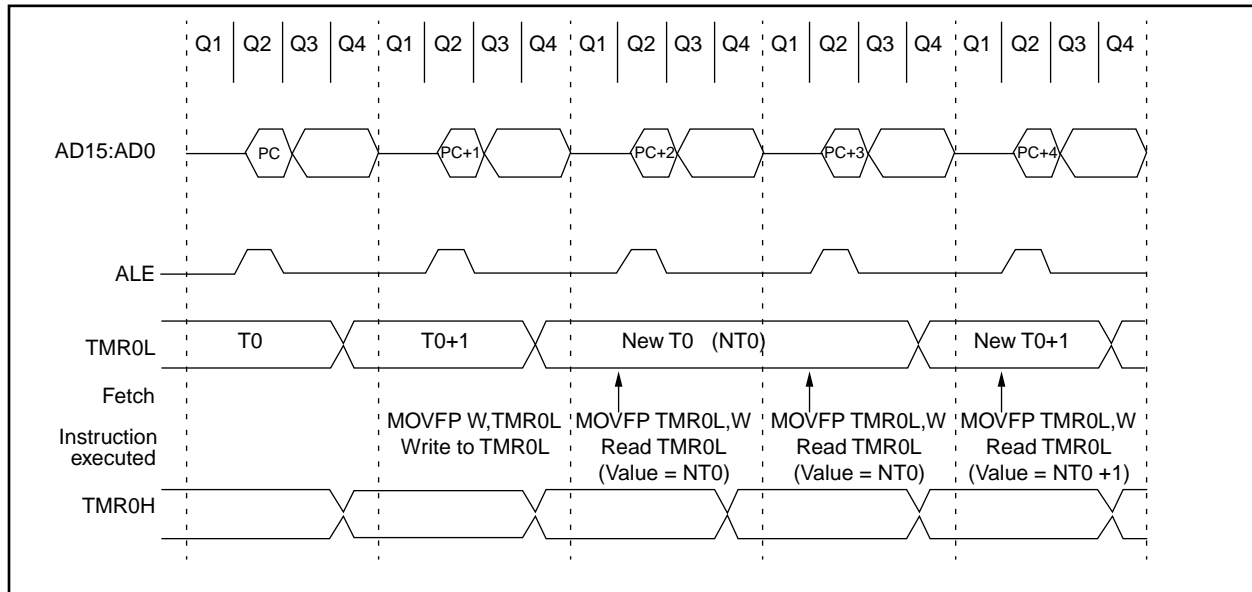
```

BSF    CPUSTA, GLINTD ; Disable interrupt
MOVFP  RAM_L, TMR0L   ;
MOVFP  RAM_H, TMR0H   ;
BCF    CPUSTA, GLINTD ; Done, enable interrupt
    
```

11.4 Prescaler Assignments

Timer0 has an 8-bit prescaler. The prescaler assignment is fully under software control; i.e., it can be changed “on the fly” during program execution. When changing the prescaler assignment, clearing the prescaler is recommended before changing assignment. The value of the prescaler is “unknown,” and assigning a value that is less than the present value makes it difficult to take this unknown time into account.

FIGURE 11-4: TMR0 TIMING: WRITE HIGH OR LOW BYTE



13.0 UNIVERSAL SYNCHRONOUS ASYNCHRONOUS RECEIVER TRANSMITTER (USART) MODULE

The USART module is a serial I/O module. The USART can be configured as a full duplex asynchronous system that can communicate with peripheral devices such as CRT terminals and personal computers, or it can be configured as a half duplex synchronous system that can communicate with peripheral devices such as A/D or D/A integrated circuits, Serial EEPROMs etc. The USART can be configured in the following modes:

- Asynchronous (full duplex)
- Synchronous - Master (half duplex)
- Synchronous - Slave (half duplex)

The SPEN (RCSTA<7>) bit has to be set in order to configure RA4 and RA5 as the Serial Communication Interface.

The USART module will control the direction of the RA4/RX/DT and RA5/TX/CK pins, depending on the states of the USART configuration bits in the RCSTA and TXSTA registers. The bits that control I/O direction are:

- SPEN
- TXEN
- SREN
- CREN
- CSRC

The Transmit Status And Control Register is shown in Figure 13-1, while the Receive Status And Control Register is shown in Figure 13-2.

FIGURE 13-1: TXSTA REGISTER (ADDRESS: 15h, BANK 0)

R/W - 0	R/W - 0	R/W - 0	R/W - 0	U - 0	U - 0	R - 1	R/W - x
CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D
bit7							bit0

R = Readable bit
W = Writable bit
-n = Value at POR reset
(x = unknown)

bit 7: **CSRC**: Clock Source Select bit
Synchronous mode:
1 = Master Mode (Clock generated internally from BRG)
0 = Slave mode (Clock from external source)
Asynchronous mode:
Don't care

bit 6: **TX9**: 9-bit Transmit Enable bit
1 = Selects 9-bit transmission
0 = Selects 8-bit transmission

bit 5: **TXEN**: Transmit Enable bit
1 = Transmit enabled
0 = Transmit disabled
SREN/CREN overrides TXEN in SYNC mode

bit 4: **SYNC**: USART mode Select bit
(Synchronous/Asynchronous)
1 = Synchronous mode
0 = Asynchronous mode

bit 3-2: **Unimplemented**: Read as '0'

bit 1: **TRMT**: Transmit Shift Register (TSR) Empty bit
1 = TSR empty
0 = TSR full

bit 0: **TX9D**: 9th bit of transmit data (can be used to calculate the parity in software)

FIGURE 13-5: ASYNCHRONOUS MASTER TRANSMISSION

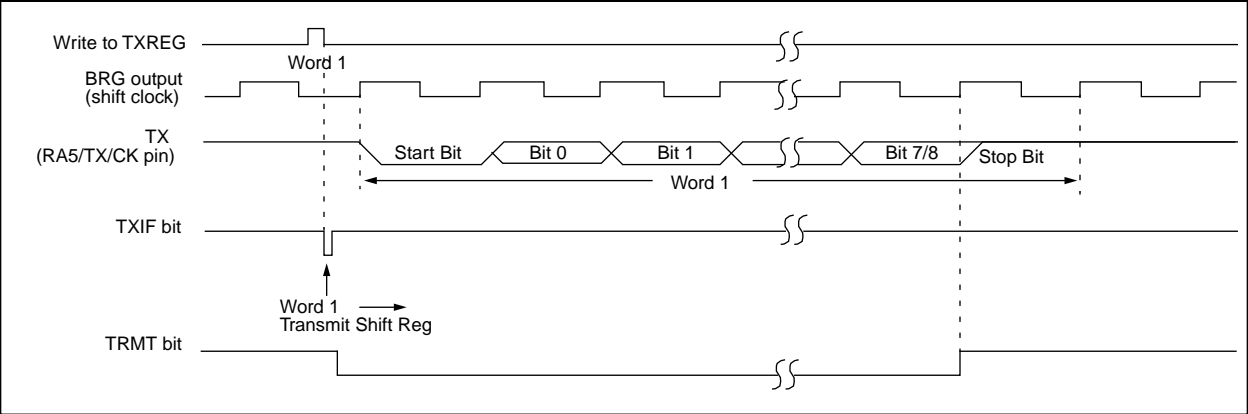


FIGURE 13-6: ASYNCHRONOUS MASTER TRANSMISSION (BACK TO BACK)

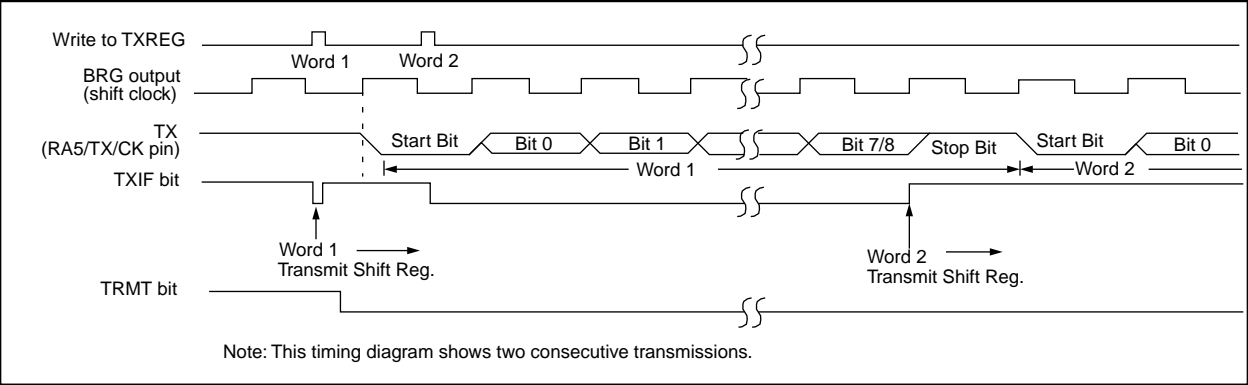


TABLE 13-5: REGISTERS ASSOCIATED WITH ASYNCHRONOUS TRANSMISSION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
13h, Bank 0	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00u
16h, Bank 0	TXREG	Serial port transmit register								xxxx xxxx	uuuu uuuu
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u
17h, Bank 0	SPBRG	Baud rate generator register								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as a '0', shaded cells are not used for asynchronous transmission.

Note 1: Other (non power-up) resets include: external reset through $\overline{\text{MCLR}}$ and Watchdog Timer Reset.

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Steps to follow when setting up an Asynchronous Reception:

1. Initialize the SPBRG register for the appropriate baud rate.
2. Enable the asynchronous serial port by clearing the SYNC bit and setting the SPEN bit.
3. If interrupts are desired, then set the RCIE bit.
4. If 9-bit reception is desired, then set the RX9 bit.
5. Enable the reception by setting the CREN bit.
6. The RCIF bit will be set when reception completes and an interrupt will be generated if the RCIE bit was set.
7. Read RCSTA to get the ninth bit (if enabled) and FERR bit to determine if any error occurred during reception.
8. Read RCREG for the 8-bit received data.
9. If an overrun error occurred, clear the error by clearing the OERR bit.

Note: To terminate a reception, either clear the SREN and CREN bits, or the SPEN bit. This will reset the receive logic, so that it will be in the proper state when receive is re-enabled.

FIGURE 13-8: ASYNCHRONOUS RECEPTION

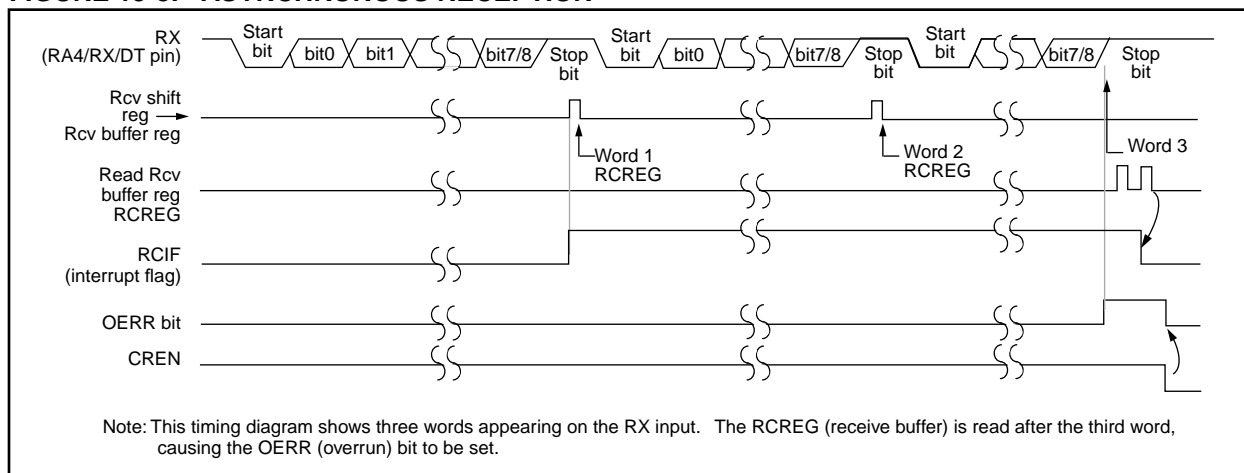


TABLE 13-6: REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on Power-on Reset	Value on all other resets (Note1)
16h, Bank 1	PIR	RBIF	TMR3IF	TMR2IF	TMR1IF	CA2IF	CA1IF	TXIF	RCIF	0000 0010	0000 0010
13h, Bank 0	RCSTA	SPEN	RX9	SREN	CREN	—	FERR	OERR	RX9D	0000 -00x	0000 -00u
14h, Bank 0	RCREG	RX7	RX6	RX5	RX4	RX3	RX2	RX1	RX0	xxxx xxxx	uuuu uuuu
17h, Bank 1	PIE	RBIE	TMR3IE	TMR2IE	TMR1IE	CA2IE	CA1IE	TXIE	RCIE	0000 0000	0000 0000
15h, Bank 0	TXSTA	CSRC	TX9	TXEN	SYNC	—	—	TRMT	TX9D	0000 --1x	0000 --1u
17h, Bank 0	SPBRG	Baud rate generator register								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented read as a '0', shaded cells are not used for asynchronous reception.

Note 1: Other (non power-up) resets include: external reset through MCLR and Watchdog Timer Reset.

RETFIE Return from Interrupt

Syntax: [*label*] RETFIE

Operands: None

Operation: TOS → (PC);
0 → GLINTD;
PCLATH is unchanged.

Status Affected: GLINTD

Encoding:

0000	0000	0000	0101
------	------	------	------

Description: Return from Interrupt. Stack is POP'ed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by clearing the GLINTD bit. GLINTD is the global interrupt disable bit (CPUSTA<4>).

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register TOSTA	Execute	NOP
Forced NOP	NOP	Execute	NOP

Example: RETFIE

After Interrupt
PC = TOS
GLINTD = 0

RETLW Return Literal to WREG

Syntax: [*label*] RETLW k

Operands: $0 \leq k \leq 255$

Operation: k → (WREG); TOS → (PC);
PCLATH is unchanged

Status Affected: None

Encoding:

1011	0110	kkkk	kkkk
------	------	------	------

Description: WREG is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). The high address latch (PCLATH) remains unchanged.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Execute	Write to WREG
Forced NOP	NOP	Execute	NOP

Example:

```
CALL TABLE ; WREG contains table
               ; offset value
               ; WREG now has
               ; table value
:
TABLE
  ADDWF PC    ; WREG = offset
  RETLW k0    ; Begin table
  RETLW k1    ;
  :
  :
  RETLW kn    ; End of table
```

Before Instruction
WREG = 0x07

After Instruction
WREG = value of k7

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RETURN Return from Subroutine

Syntax: [*label*] RETURN

Operands: None

Operation: TOS → PC;

Status Affected: None

Encoding:

0000	0000	0000	0010
------	------	------	------

Description: Return from subroutine. The stack is popped and the top of the stack (TOS) is loaded into the program counter.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register PCL*	Execute	NOP
Forced NOP	NOP	Execute	NOP

* Remember reading PCL causes PCLATH to be updated. This will be the high address of where the RETURN instruction is located.

Example: RETURN

After Interrupt
PC = TOS

RLCF Rotate Left f through Carry

Syntax: [*label*] RLCF f,d

Operands: $0 \leq f \leq 255$
 $d \in [0,1]$

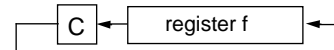
Operation: $f\langle n \rangle \rightarrow d\langle n+1 \rangle$;
 $f\langle 7 \rangle \rightarrow C$;
 $C \rightarrow d\langle 0 \rangle$

Status Affected: C

Encoding:

0001	101d	ffff	ffff
------	------	------	------

Description: The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0 the result is placed in WREG. If 'd' is 1 the result is stored back in register 'f'.



Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Execute	Write to destination

Example: RLCF REG, 0

Before Instruction

REG = 1110 0110
C = 0

After Instruction

REG = 1110 0110
WREG = 1100 1100
C = 1

FIGURE 17-7: CAPTURE TIMINGS

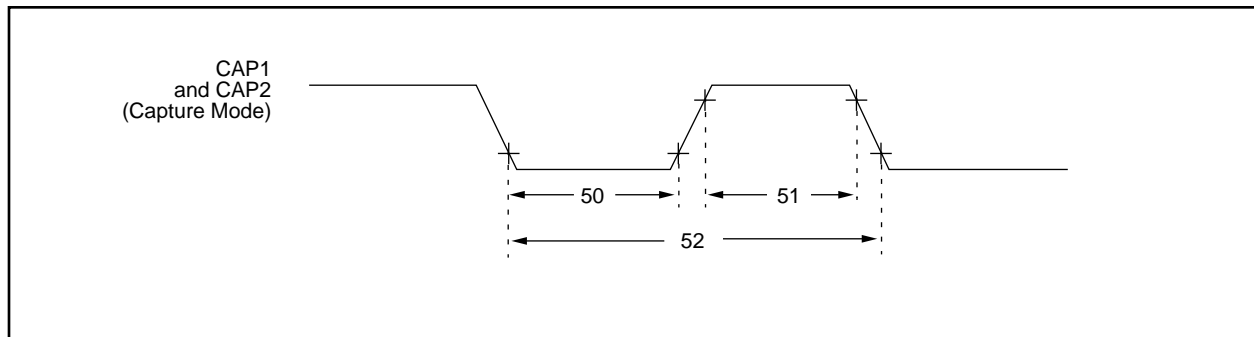


TABLE 17-7: CAPTURE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
50	TccL	Capture1 and Capture2 input low time	10 *	—	—	ns	
51	TccH	Capture1 and Capture2 input high time	10 *	—	—	ns	
52	TccP	Capture1 and Capture2 input period	$\frac{2 T_{CY}}{N}$ §	—	—	ns	N = prescale value (4 or 16)

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

FIGURE 17-8: PWM TIMINGS

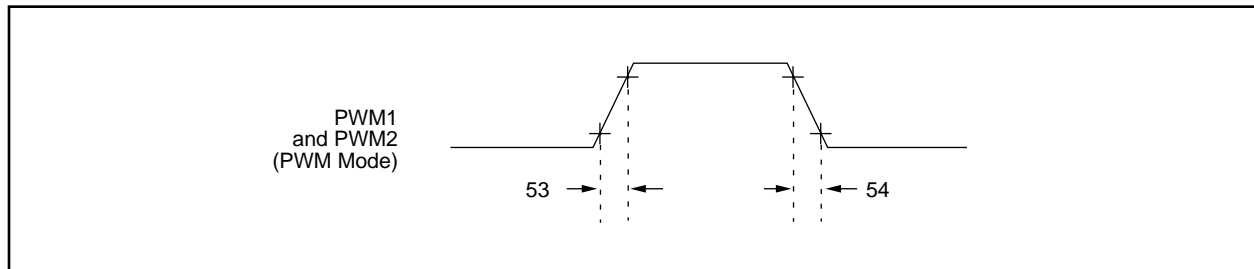


TABLE 17-8: PWM REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
53	TccR	PWM1 and PWM2 output rise time	—	10 *	35 *§	ns	
54	TccF	PWM1 and PWM2 output fall time	—	10 *	35 *§	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

§ This specification ensured by design.

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Applicable Devices 42 R42 42A 43 R43 44

FIGURE 17-9: USART MODULE: SYNCHRONOUS TRANSMISSION (MASTER/SLAVE) TIMING

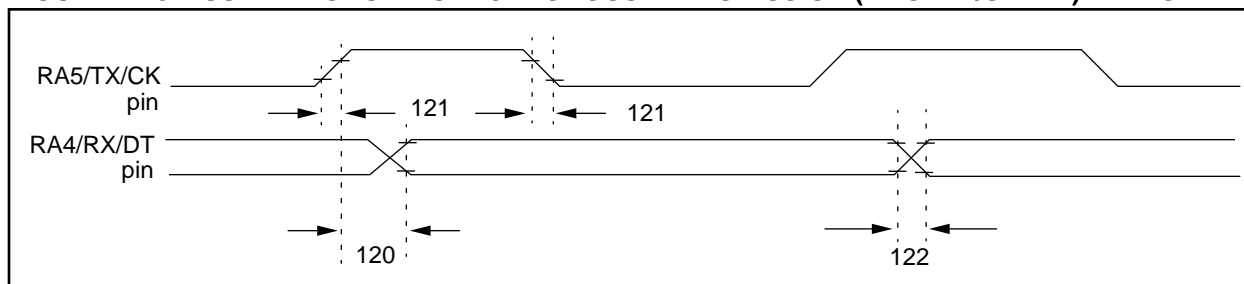


TABLE 17-9: SERIAL PORT SYNCHRONOUS TRANSMISSION REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
120	TckH2dtV	SYNC XMIT (MASTER & SLAVE) Clock high to data out valid	—	—	65	ns	
121	TckRF	Clock out rise time and fall time (Master Mode)	—	10	35	ns	
122	TdtRF	Data out rise time and fall time	—	10	35	ns	

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

FIGURE 17-10: USART MODULE: SYNCHRONOUS RECEIVE (MASTER/SLAVE) TIMING

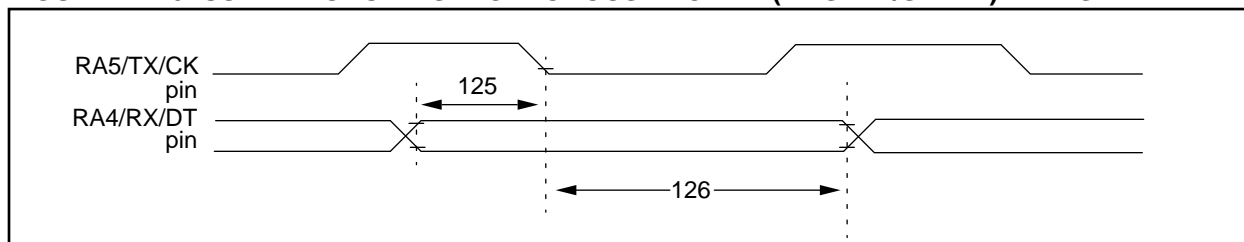


TABLE 17-10: SERIAL PORT SYNCHRONOUS RECEIVE REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
125	TdtV2ckL	SYNC RCV (MASTER & SLAVE) Data hold before CK↓ (DT hold time)	15	—	—	ns	
126	TckL2dtl	Data hold after CK↓ (DT hold time)	15	—	—	ns	

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

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Applicable Devices 42 R42 42A 43 R43 44

FIGURE 18-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

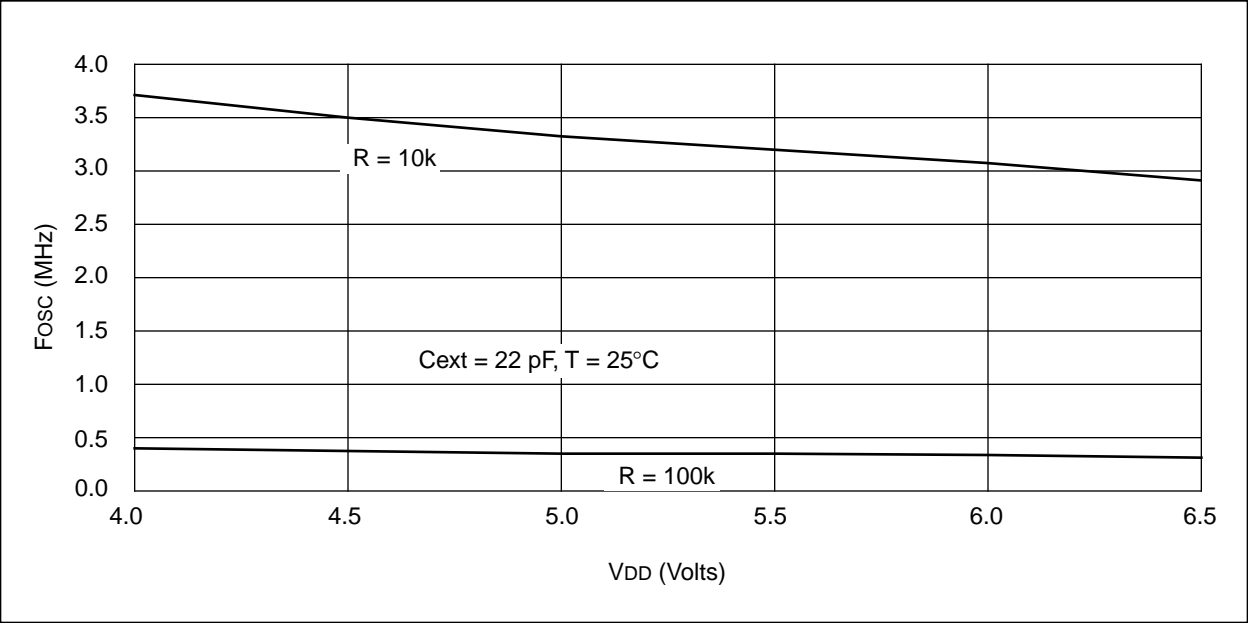
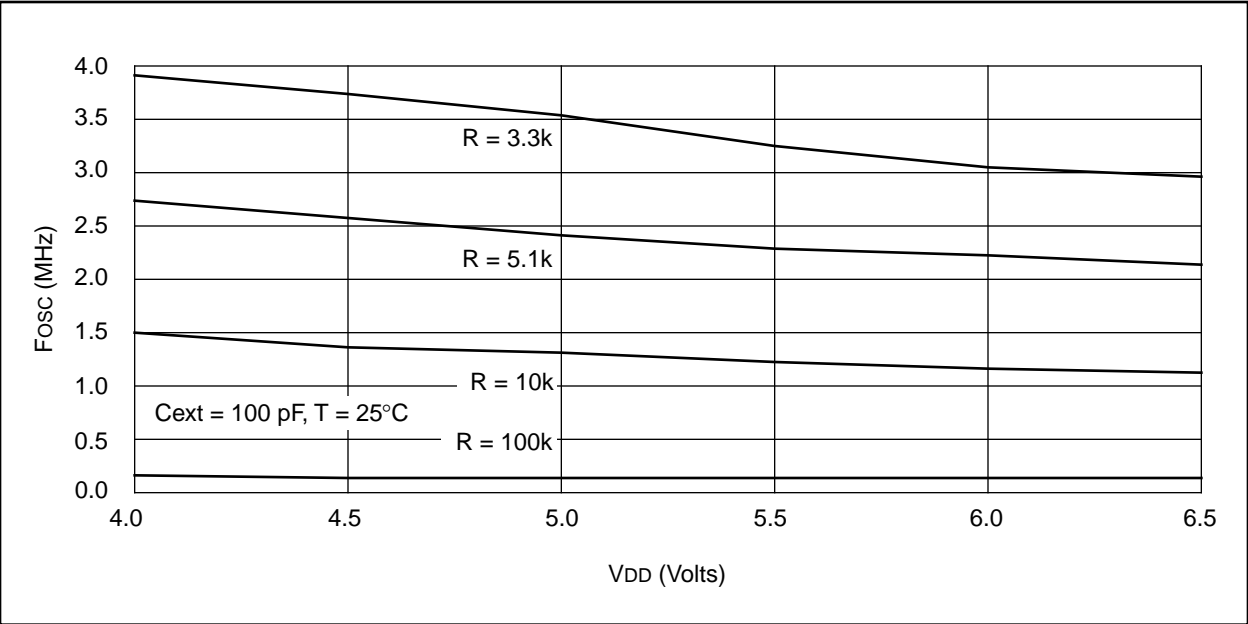


FIGURE 18-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD



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Applicable Devices 42 R42 42A 43 R43 44

FIGURE 18-5: TRANSCONDUCTANCE (gm) OF LF OSCILLATOR vs. VDD

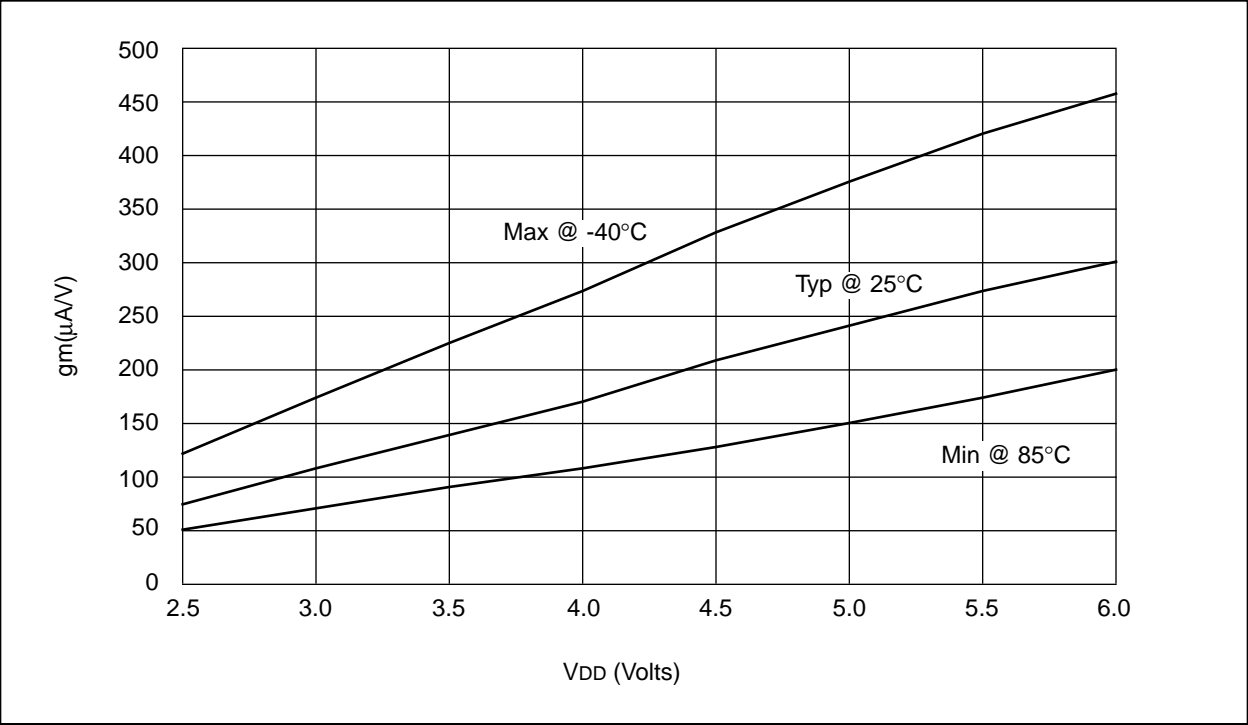
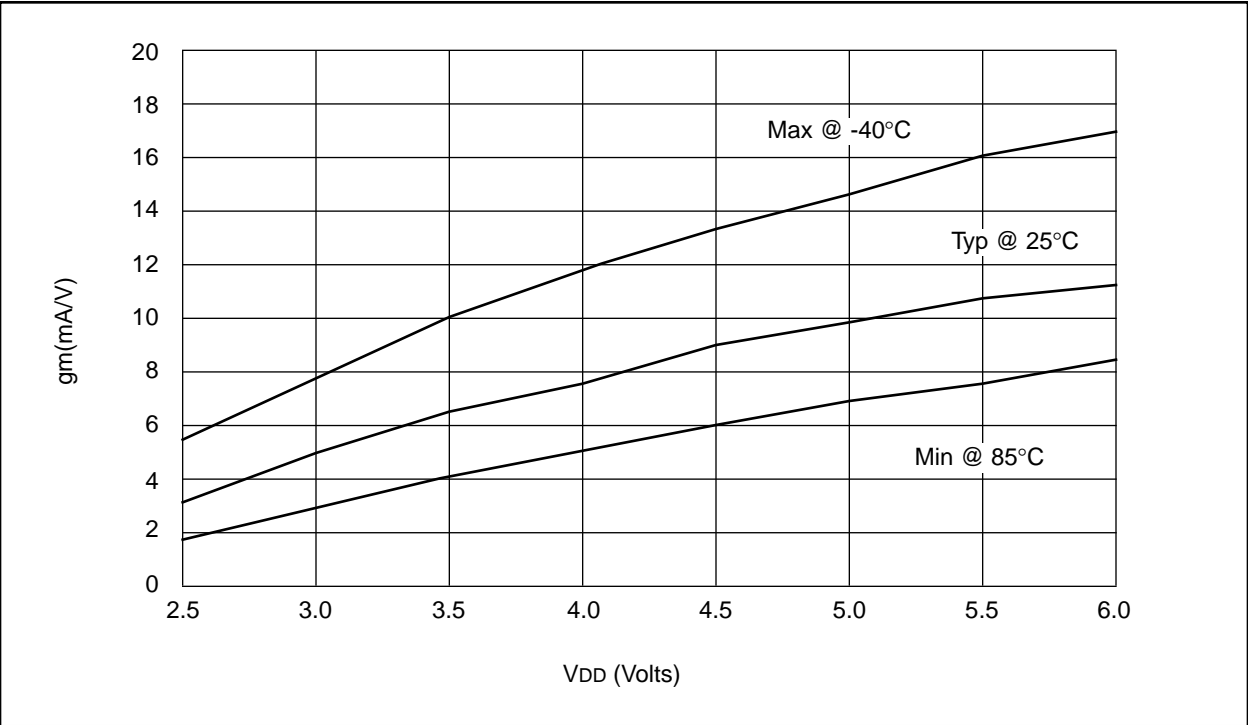


FIGURE 18-6: TRANSCONDUCTANCE (gm) OF XT OSCILLATOR vs. VDD



19.1 DC CHARACTERISTICS: **PIC17CR42/42A/43/R43/44-16 (Commercial, Industrial)**
PIC17CR42/42A/43/R43/44-25 (Commercial, Industrial)
PIC17CR42/42A/43/R43/44-33 (Commercial, Industrial)

Standard Operating Conditions (unless otherwise stated)						
Operating temperature						
<div> <div>DC CHARACTERISTICS</div> <div> <div>-40°C</div> <div>≤ TA ≤ +85°C for industrial and</div> </div> <div> <div>0°C</div> <div>≤ TA ≤ +70°C for commercial</div> </div> </div>						
Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units
D001	VDD	Supply Voltage	4.5	–	6.0	V
D002	VDR	RAM Data Retention Voltage (Note 1)	1.5 *	–	–	V
D003	VPOR	VDD start voltage to ensure internal Power-on Reset signal	–	VSS	–	V
D004	SVDD	VDD rise rate to ensure internal Power-on Reset signal	0.060 *	–	–	mV/ms
D010 D011 D012 D013 D015 D014	IDD	Supply Current (Note 2)	– – – – – –	3 6 11 19 25 95	6 12 * 24 * 38 50 150	mA mA mA mA mA μA
D020 D021	IPD	Power-down Current (Note 3)	– –	10 < 1	40 5	μA μA
<div> <div>FOSC = 4 MHz (Note 4)</div> <div>FOSC = 8 MHz</div> <div>FOSC = 16 MHz</div> <div>FOSC = 25 MHz</div> <div>FOSC = 33 MHz</div> <div>FOSC = 32 kHz, WDT enabled (EC osc configuration)</div> </div>						
<div> <div>VDD = 5.5V, WDT enabled</div> <div>VDD = 5.5V, WDT disabled</div> </div>						

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in active operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tristated, pulled to VDD or VSS, T0CKI = VDD, MCLR = VDD; WDT enabled/disabled as specified.

Current consumed from the oscillator and I/O's driving external capacitive or resistive loads needs to be considered.

For the RC oscillator, the current through the external pull-up resistor (R) can be estimated as: $V_{DD} / (2 \cdot R)$.

For capacitive loads, the current can be estimated (for an individual I/O pin) as $(C_L \cdot V_{DD}) \cdot f$

C_L = Total capacitive load on the I/O pin; f = average frequency the I/O pin switches.

The capacitive currents are most significant when the device is configured for external execution (includes extended microcontroller mode).

3: The power down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD and VSS.

4: For RC osc configuration, current through Rext is not included. The current through the resistor can be estimated by the formula $I_R = V_{DD}/2R_{ext}$ (mA) with R_{ext} in kOhm.

FIGURE 19-3: CLKOUT AND I/O TIMING

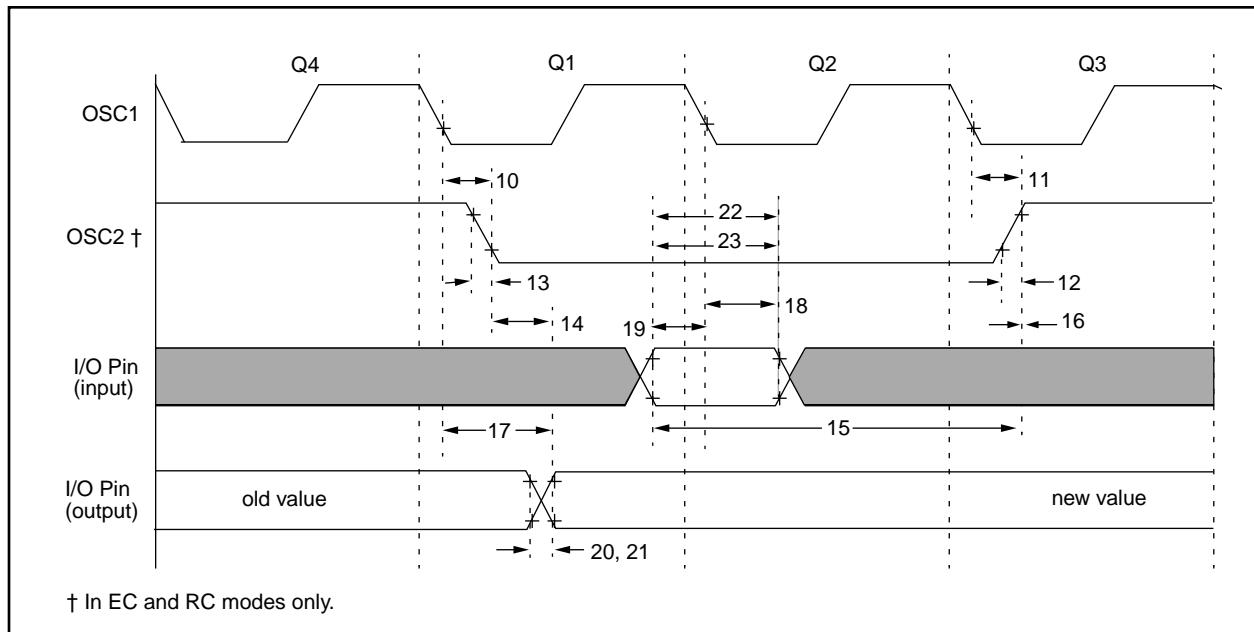


TABLE 19-3: CLKOUT AND I/O TIMING REQUIREMENTS

Parameter No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
10	TosH2ckL	OSC1↓ to CLKOUT↓	—	15 ‡	30 ‡	ns	Note 1
11	TosH2ckH	OSC1↓ to CLKOUT↑	—	15 ‡	30 ‡	ns	Note 1
12	TckR	CLKOUT rise time	—	5 ‡	15 ‡	ns	Note 1
13	TckF	CLKOUT fall time	—	5 ‡	15 ‡	ns	Note 1
14	TckH2ioV	CLKOUT ↑ to Port out valid	PIC17CR42/42A/43/R43/44	—	0.5T _{cy} + 20 ‡	ns	Note 1
			PIC17LCR42/42A/43/R43/44	—	0.5T _{cy} + 50 ‡	ns	Note 1
15	TioV2ckH	Port in valid before CLKOUT↑	PIC17CR42/42A/43/R43/44	0.25T _{cy} + 25 ‡	—	ns	Note 1
			PIC17LCR42/42A/43/R43/44	0.25T _{cy} + 50 ‡	—	ns	Note 1
16	TckH2ioL	Port in hold after CLKOUT↑	0 ‡	—	—	ns	Note 1
17	TosH2ioV	OSC1↓ (Q1 cycle) to Port out valid	—	—	100 ‡	ns	
18	TosH2ioL	OSC1↓ (Q2 cycle) to Port input invalid (I/O in hold time)	0 ‡	—	—	ns	
19	TioV2osH	Port input valid to OSC1↓ (I/O in setup time)	30 ‡	—	—	ns	
20	TioR	Port output rise time	—	10 ‡	35 ‡	ns	
21	TioF	Port output fall time	—	10 ‡	35 ‡	ns	
22	TinHL	INT pin high or low time	25 *	—	—	ns	
23	TrbHL	RB7:RB0 change INT high or low time	25 *	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

‡ These parameters are for design guidance only and are not tested, nor characterized.

Note 1: Measurements are taken in EC Mode where CLKOUT output is 4 x T_{osc}.

PIC17C4X

Applicable Devices 42 R42 42A 43 R43 44

FIGURE 20-2: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

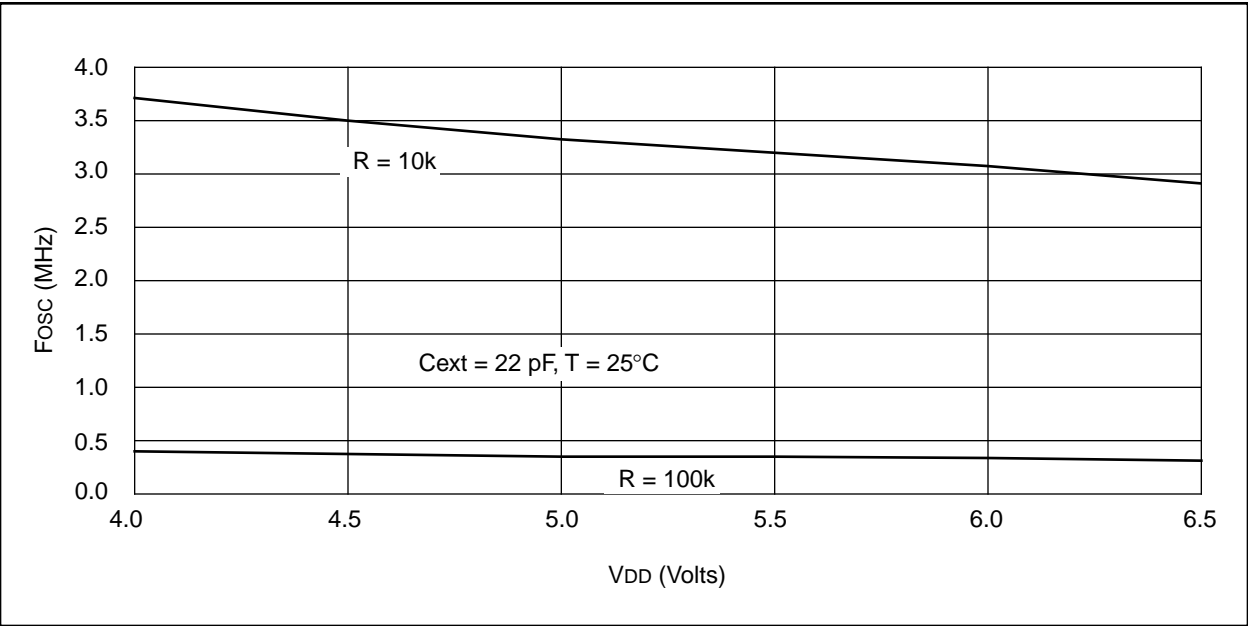
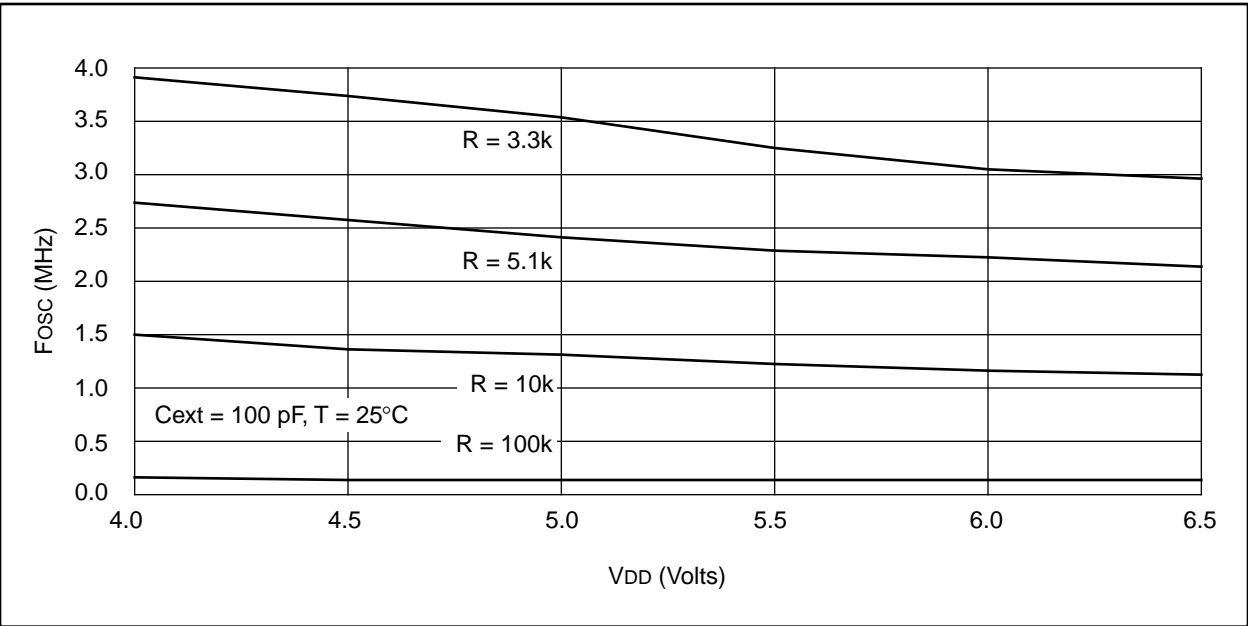


FIGURE 20-3: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD



APPENDIX C: WHAT'S NEW

The structure of the document has been made consistent with other data sheets. This ensures that important topics are covered across all PIC16/17 families. Here is an overview of new features.

Added the following devices:

PIC17CR42

PIC17C42A

PIC17CR43

A 33 MHz option is now available.

APPENDIX D: WHAT'S CHANGED

To make software more portable across the different PIC16/17 families, the name of several registers and control bits have been changed. This allows control bits that have the same function, to have the same name (regardless of processor family). Care must still be taken, since they may not be at the same special function register address. The following shows the register and bit names that have been changed:

Old Name	New Name
TX8/9	TX9
RC8/9	RX9
RCD8	RX9D
TXD8	TX9D

Instruction DECFSNZ corrected to DCFSNZ

Instruction INCFSNZ corrected to INFSNZ

Enhanced discussion on PWM to include equation for determining bits of PWM resolution.

Section 13.2.2 and 13.3.2 have had the description of updating the FERR and RX9 bits enhanced.

The location of configuration bit PM2 was changed (Figure 6-1 and Figure 14-1).

Enhanced description of the operation of the INTSTA register.

Added note to discussion of interrupt operation.

Tightened electrical spec D110.

Corrected steps for setting up USART Asynchronous Reception.

PIC17C4X

E.6 PIC16C8X Family of Devices

	Clock			Memory			Peripherals		Features										
	Maximum Frequency of Operation (MHz)			Program Memory			Data EEPROM (bytes)			Timer Modules		Interrupt Sources		I/O Pins		Voltage Range (Volts)		Packages	
	Flash	EEPROM	ROM	Data Memory (bytes)	Data EEPROM (bytes)	Timer Modules	Interrupt Sources	I/O Pins	Voltage Range (Volts)	Packages									
PIC16C84	10	—	1K	—	36	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC								
PIC16F84 ⁽¹⁾	10	1K	—	—	68	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC								
PIC16CR84 ⁽¹⁾	10	—	—	1K	68	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC								
PIC16F83 ⁽¹⁾	10	512	—	—	36	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC								
PIC16CR83 ⁽¹⁾	10	—	—	512	36	64	TMR0	4	13	2.0-6.0	18-pin DIP, SOIC								

All PIC16/17 family devices have Power-on Reset, selectable Watchdog Timer, selectable code protect, and high I/O current capability.

All PIC16C8X family devices use serial programming with clock pin RB6 and data pin RB7.

Note 1: Please contact your local sales office for availability of these devices.

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